



STS2620

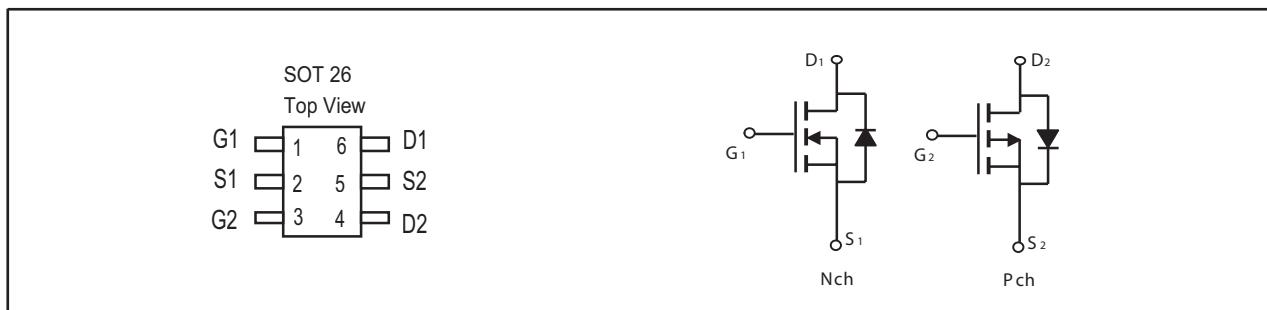
SamHop Microelectronics Corp.

Ver1.2

Dual Enhancement Mode Field Effect Transistor (N and P Channel)

PRODUCT SUMMARY (N-Channel)		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
20V	2.5A	53 @ V _{GS} =4.5V
		78 @ V _{GS} =2.5V

PRODUCT SUMMARY (P-Channel)		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
-20V	-2A	103 @ V _{GS} =-4.5V
		190 @ V _{GS} =-2.5V



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Symbol	Parameter	N-Channel	P-Channel	Units	
V _{DS}	Drain-Source Voltage	20	-20	V	
V _{GS}	Gate-Source Voltage	±10	±10	V	
I _D	Drain Current-Continuous ^a	T _C =25°C	2.5	-2	A
		T _C =70°C	2	-1.6	A
I _{DM}	-Pulsed ^b	8	-7	A	
P _D	Maximum Power Dissipation ^a	T _C =25°C	1	W	
		T _C =70°C	0.64	W	
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150		°C	

THERMAL CHARACTERISTICS

R _{θJA}	Thermal Resistance, Junction-to-Ambient ^a	125	°C/W
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Details are subject to change without notice.

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N-Channel ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_D=250\mu\text{A}$	20			V
I_{DSS}	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}}=16\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$			1	μA
I_{GSS}	Gate-Body Leakage Current	$\text{V}_{\text{GS}}=\pm 10\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$			± 100	nA
ON CHARACTERISTICS						
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$, $\text{I}_D=250\mu\text{A}$	0.5	0.8	1.5	V
$\text{R}_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$\text{V}_{\text{GS}}=4.5\text{V}$, $\text{I}_D=2.5\text{A}$		42	53	m ohm
		$\text{V}_{\text{GS}}=2.5\text{V}$, $\text{I}_D=2\text{A}$		58	78	m ohm
g_{FS}	Forward Transconductance	$\text{V}_{\text{DS}}=5\text{V}$, $\text{I}_D=2.5\text{A}$		7		S
DYNAMIC CHARACTERISTICS ^c						
C_{iss}	Input Capacitance	$\text{V}_{\text{DS}}=10\text{V}, \text{V}_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$		232		pF
C_{oss}	Output Capacitance			82		pF
C_{rss}	Reverse Transfer Capacitance			66		pF
SWITCHING CHARACTERISTICS ^c						
$t_{\text{D}(\text{ON})}$	Turn-On Delay Time	$\text{V}_{\text{DD}}=10\text{V}$ $\text{I}_D=1\text{A}$ $\text{V}_{\text{GS}}=4.5\text{V}$ $\text{R}_{\text{GEN}}=6\text{ ohm}$		9.4		ns
t_{r}	Rise Time			13.6		ns
$t_{\text{D}(\text{OFF})}$	Turn-Off Delay Time			15.7		ns
t_{f}	Fall Time			9.8		ns
Q_g	Total Gate Charge	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=2.5\text{A}$, $\text{V}_{\text{GS}}=4.5\text{V}$		5.6		nC
Q_{gs}	Gate-Source Charge			1.2		nC
Q_{gd}	Gate-Drain Charge			2.4		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V_{SD}	Diode Forward Voltage	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=1\text{A}$		0.8	1.2	V

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P-Channel ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-16V, V _{GS} =0V			1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±10V, V _{DS} =0V			±100	nA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.5	-0.9	-1.5	V
R _{D(S(ON))}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-2A		82	103	m ohm
		V _{GS} =-2.5V, I _D =-1A		140	190	m ohm
g _{Fs}	Forward Transconductance	V _{DS} =-5V, I _D =-2A		6.3		S
DYNAMIC CHARACTERISTICS ^c						
C _{iss}	Input Capacitance	V _{DS} =-10V, V _{GS} =0V f=1.0MHz		172		pF
C _{oss}	Output Capacitance			82		pF
C _{rss}	Reverse Transfer Capacitance			37		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =-10V I _D =-1A V _{GS} =-4.5V R _{GEN} =6 ohm		41		ns
t _r	Rise Time			151		ns
t _{D(OFF)}	Turn-Off Delay Time			384		ns
t _f	Fall Time			320		ns
Q _g	Total Gate Charge	V _{DS} =-10V, I _D =-2A, V _{GS} =-4.5V		3.4		nC
Q _{gs}	Gate-Source Charge			0.4		nC
Q _{gd}	Gate-Drain Charge			1.6		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _s =1A		-0.8	-1.2	V
Notes						
a.Surface Mounted on FR4 Board,t≤10sec.						
b.Pulse Test:Pulse Width ≤300us, Duty Cycle ≤2%.						
c.Guaranteed by design, not subject to production testing.						

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N-Channel

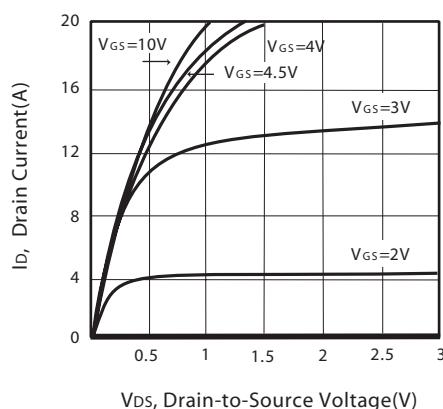


Figure 1. Output Characteristics

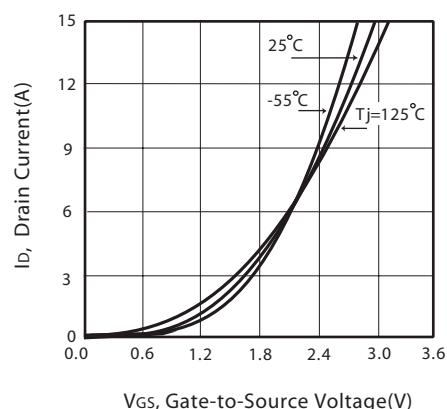


Figure 2. Transfer Characteristics

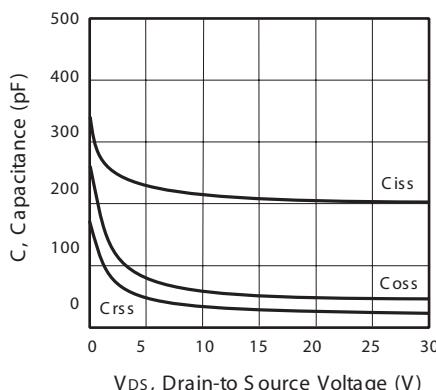


Figure 3. Capacitance

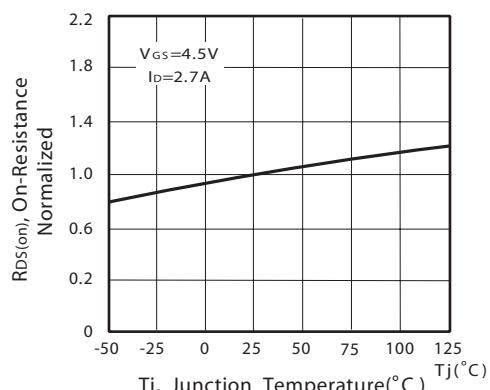


Figure 4. On-Resistance Variation with Temperature

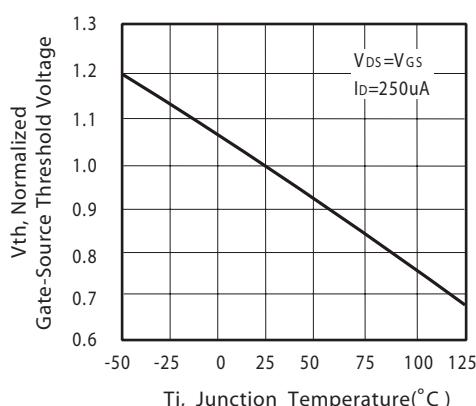


Figure 5. Gate Threshold Variation with Temperature

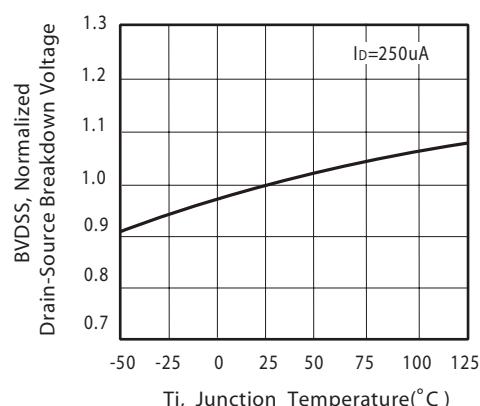


Figure 6. Breakdown Voltage Variation with Temperature

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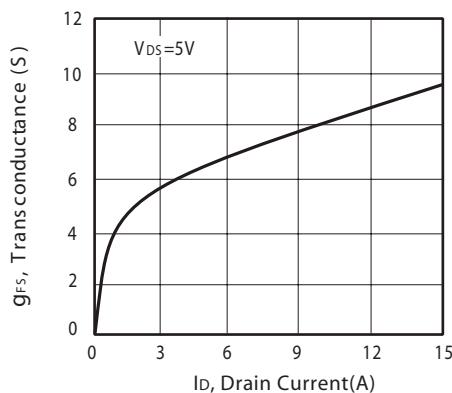


Figure 7. Transconductance Variation with Drain Current

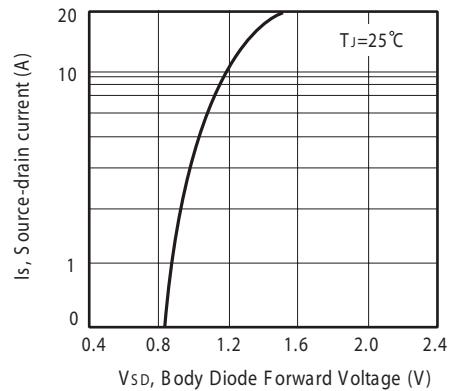


Figure 8. Body Diode Forward Voltage Variation with Source Current

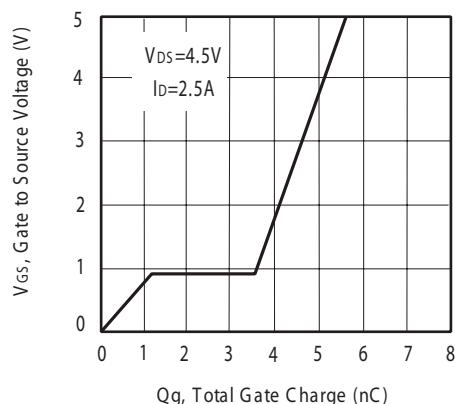


Figure 9. Gate Charge

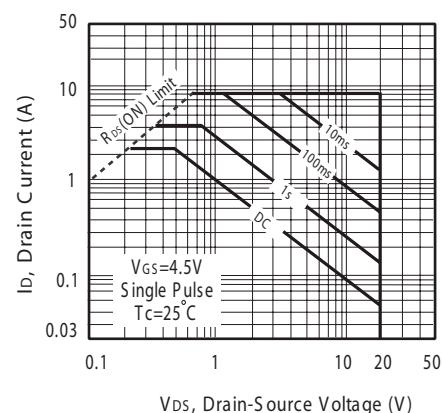
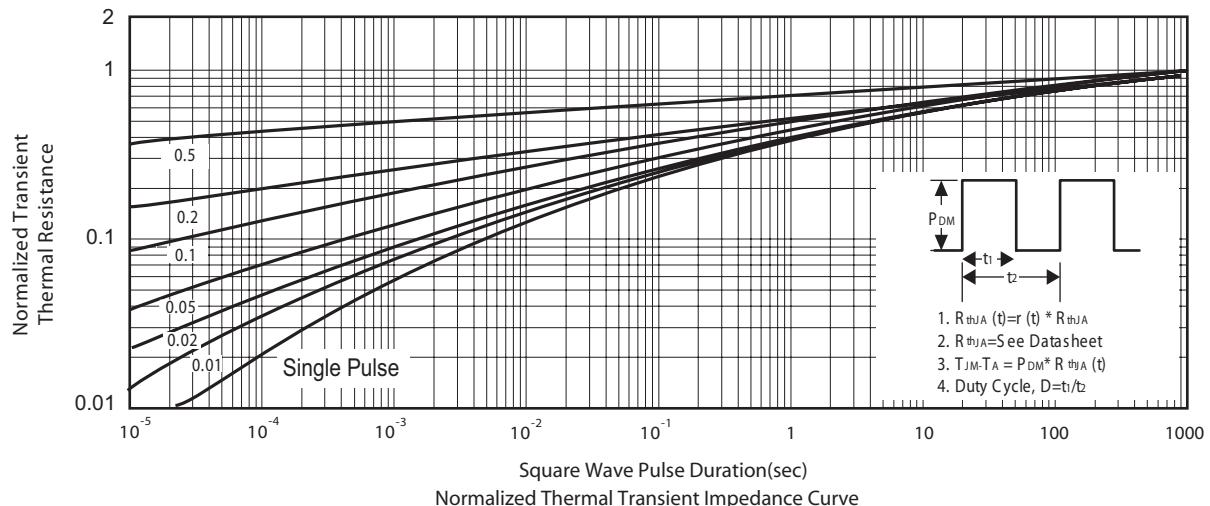


Figure 10. Maximum Safe Operating Area



P-Channel

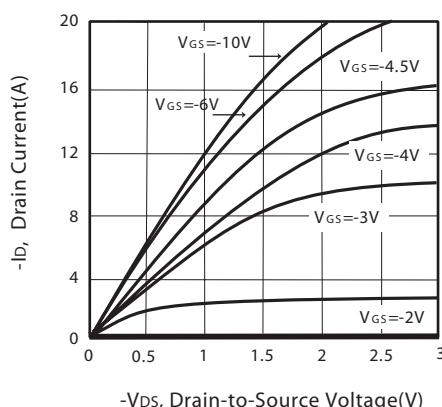


Figure 1. Output Characteristics

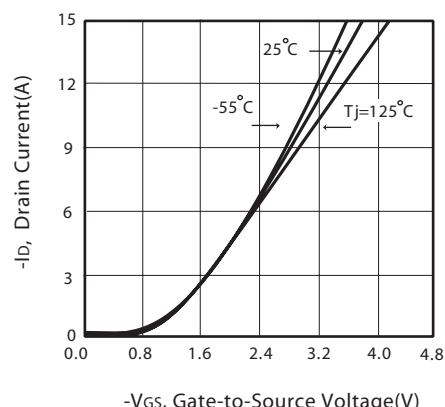


Figure 2. Transfer Characteristics

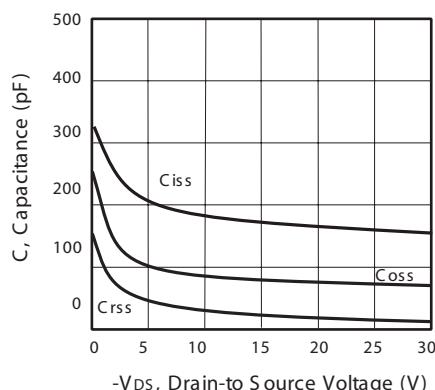


Figure 3. Capacitance

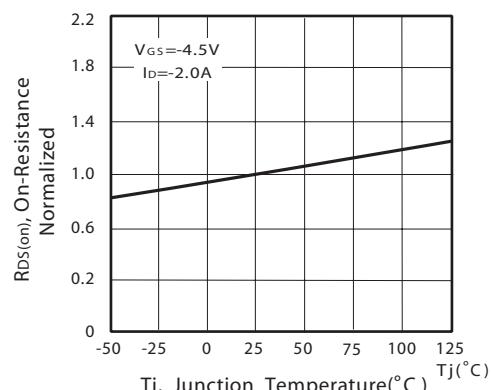


Figure 4. On-Resistance Variation with Temperature

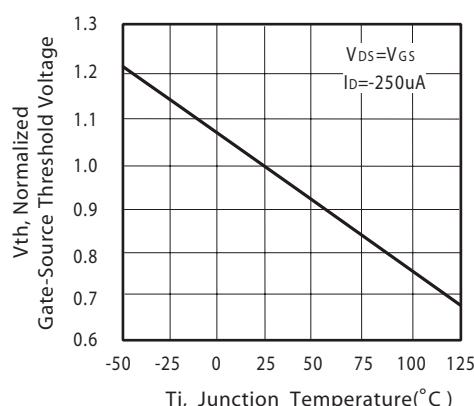


Figure 5. Gate Threshold Variation with Temperature

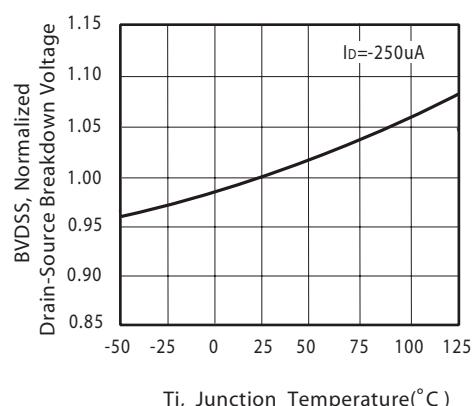


Figure 6. Breakdown Voltage Variation with Temperature

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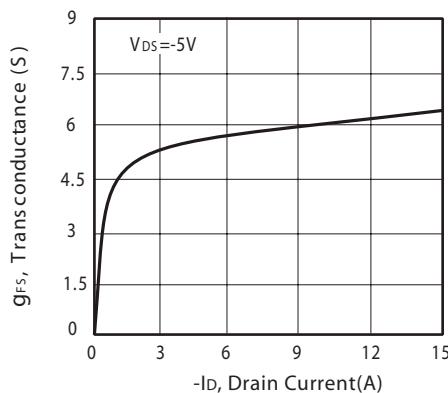


Figure 7. Transconductance Variation with Drain Current

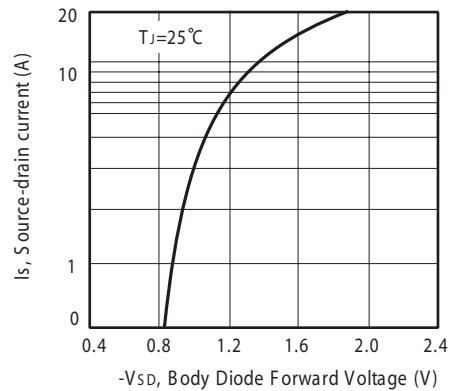


Figure 8. Body Diode Forward Voltage Variation with Source Current

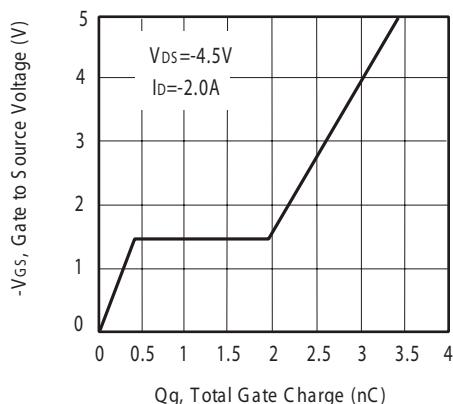


Figure 9. Gate Charge

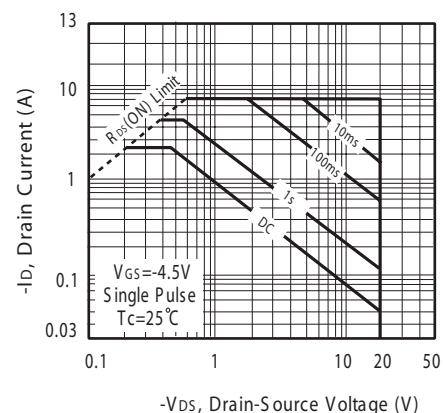
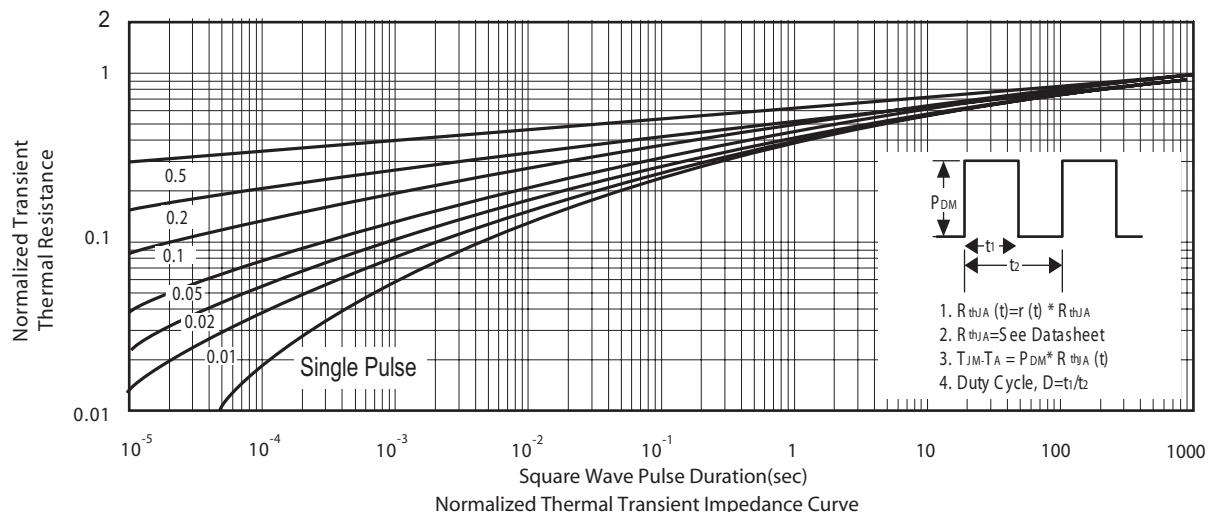
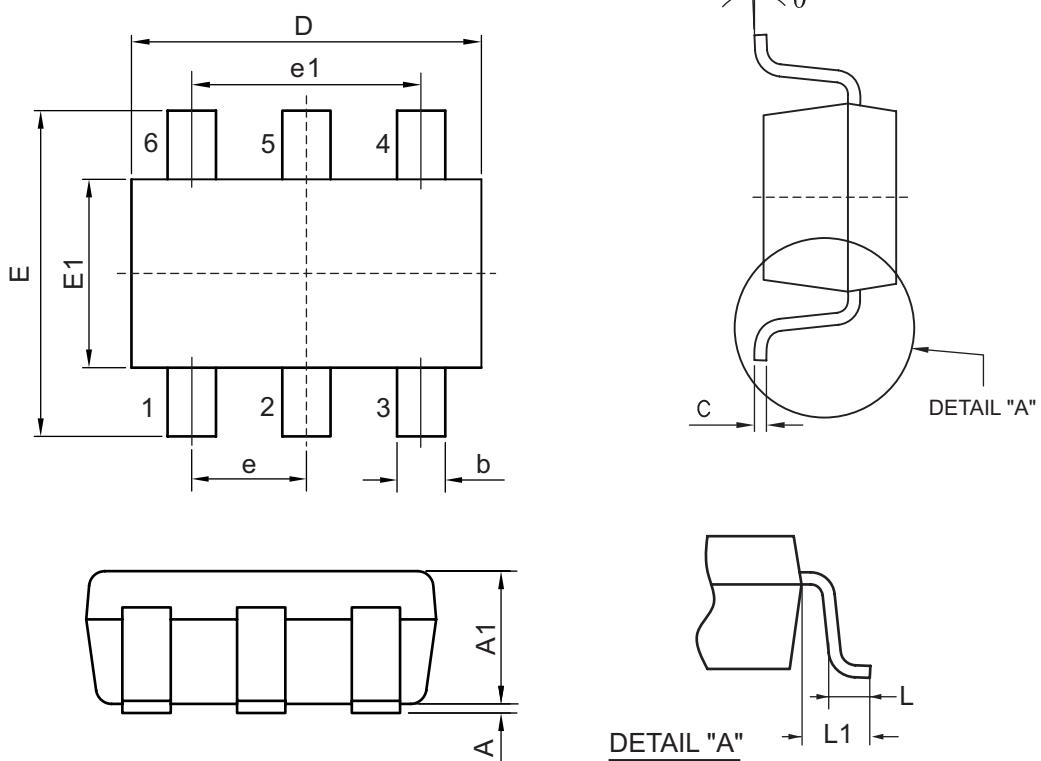


Figure 10. Maximum Safe Operating Area



PACKAGE OUTLINE DIMENSIONS

SOT 26



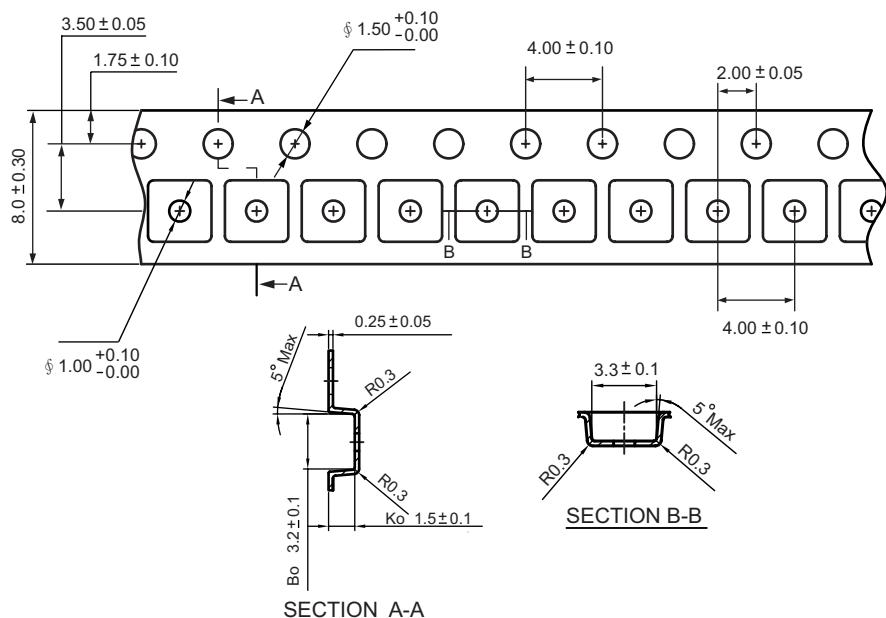
SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
D	2.700	3.100	0.106	0.122
E	2.500	3.100	0.098	0.122
E1	1.400	1.800	0.055	0.071
e	0.950 REF.		0.037 REF.	
e1	1.900 REF.		0.075 REF.	
b	0.300	0.500	0.012	0.020
C	0.090	0.200	0.004	0.008
A	0.000	0.130	0.000	0.005
A1	0.700	1.120	0.028	0.044
L	0.300	0.550	0.012	0.022
L1	0.350	0.800	0.014	0.031
θ	0°	10°	0°	10°

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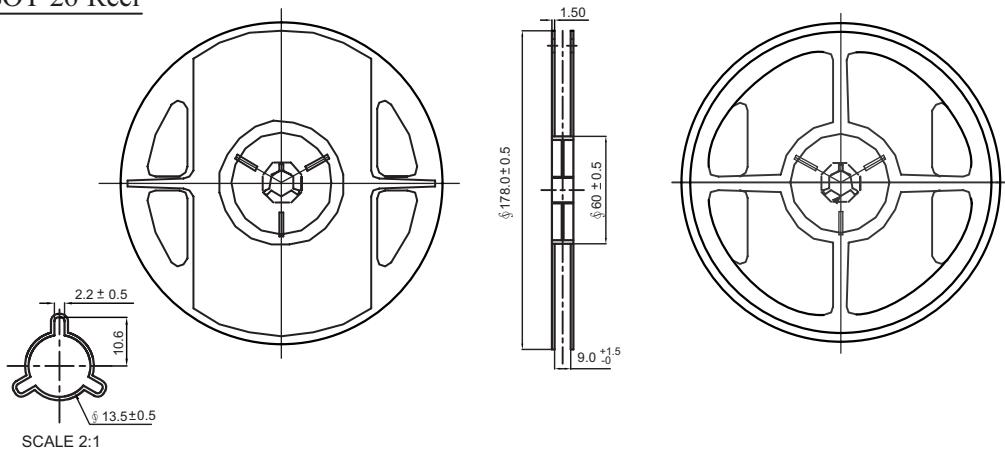
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SOT 26 Tape and Reel Data

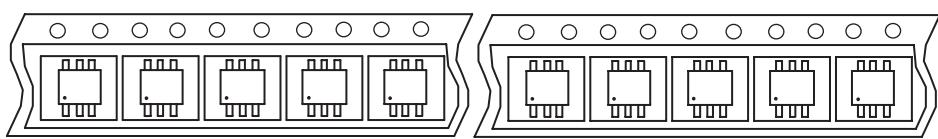
SOT 26 Carrier Tape



SOT 26 Reel



SCALE 2:1



SOT 26

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